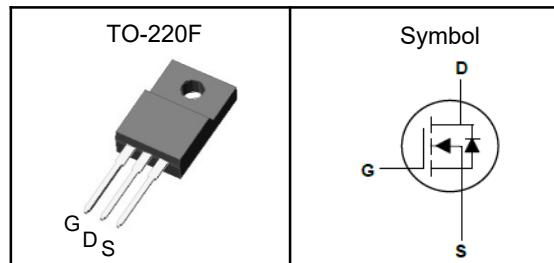


## N-Channel Enhancement Mode MOSFET

### Features

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant
- 100% UIS and Rg Tested

### Pin Description



### Applications

- Power Management in Desktop Computer
- DC/DC Converters

|                  |      |           |
|------------------|------|-----------|
| $V_{DSS}$        | 650  | V         |
| $R_{DS(ON)-Typ}$ | 1100 | $m\Omega$ |
| $I_D$            | 7    | A         |

### Absolute Maximum Ratings ( $T_J=25^\circ C$ , Unless Otherwise Noted)

| Symbol       | Parameter                                  | Rating           | Unit       |   |
|--------------|--|------------------|------------|---|
| $V_{DSS}$    | Drain-Source Voltage                       | 650              | V          |   |
| $V_{GSS}$    | Gate-Source Voltage                        | $\pm 30$         | V          |   |
| $T_J$        | Maximum Junction Temperature               | -55 to 150       | $^\circ C$ |   |
| $T_{STG}$    | Storage Temperature Range                  | -55 to 150       | $^\circ C$ |   |
| $E_{AS}$     | Single Pulse Avalanche Energy <sup>③</sup> | 230              | mJ         |   |
| $I_{DM}^{①}$ | Pulse Drain Current Tested                 | 28               | A          |   |
| $I_D$        | Continuous Drain Current                   | $T_c=25^\circ C$ | 7          | A |
| $P_D$        | Maximum Power Dissipation                  | $T_c=25^\circ C$ | 35         | W |

### Thermal Characteristics

| Symbol    | Parameter  | Rating | Unit         |
|-----------|--|--------|--------------|
| $R_{θJA}$ | Thermal Resistance Junction-Ambient <sub>1</sub> | 62.5   | $^\circ C/W$ |
| $R_{θJC}$ | Thermal Resistance Junction-Case <sub>1</sub>    | 2.12   | $^\circ C/W$ |

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C.

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

**N-Channel Enhancement Mode MOSFET**
**Electrical Characteristics** ( $T_J=25^\circ\text{C}$ , Unless Otherwise Noted)

| Symbol   | Parameter                          | Test Conditions   | Min | Typ  | Max      | Unit             |
|--|------------------------------------|---|-----|------|----------|------------------|
| <b>Static Electrical Characteristics</b>                       |                                    |   |     |      |          |                  |
| $\text{BV}_{\text{DSS}}$                                       | Drain-Source Breakdown Voltage     | $V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$  | 650 | ---  | ---      | V                |
| $I_{\text{DSS}}$   | Zero Gate Voltage Drain Current    | $V_{\text{DS}}=650\text{V}$ , $V_{\text{GS}}=0\text{V}$   | --- | ---  | 1        | $\mu\text{A}$    |
| $V_{\text{GS(th)}}$  | Gate Threshold Voltage             | $V_{\text{DS}}=V_{\text{GS}}$ , $I_D=250\mu\text{A}$  | 2   | ---  | 4        | V                |
| $I_{\text{GSS}}$   | Gate Leakage Current               | $V_{\text{GS}}=\pm30\text{V}$ , $V_{\text{DS}}=0\text{V}$   | --- | ---  | $\pm100$ | $\text{nA}$      |
| $R_{\text{DS(ON)}}$  | Drain-Source On-state Resistance   | $V_{\text{GS}}=10\text{V}$ , $I_D=3.5\text{A}$  | --- | 1100 | 1300     | $\text{m}\Omega$ |
| <b>Dynamic Characteristics</b> <sup>⑤</sup>                    |                                    |   |     |      |          |                  |
| $C_{\text{iss}}$   | Input Capacitance                  | $V_{\text{GS}}=0\text{V}$ ,<br>$V_{\text{DS}}=25\text{V}$ ,<br>Freq.=1MHz                         | --- | 1098 | ---      | pF               |
| $C_{\text{oss}}$   | Output Capacitance                 |   | --- | 93   | ---      |                  |
| $C_{\text{rss}}$   | Reverse Transfer Capacitance       |   | --- | 11   | ---      |                  |
| $T_{\text{d(on)}}$   | Turn-on Delay Time                 | $V_{\text{DD}}=325\text{V}$ , $R_G=25\Omega$ ,<br>$I_D=7\text{A}$                                 | --- | 29   | ---      | nS               |
| $T_r$  | Turn-on Rise Time                  |   | --- | 48   | ---      |                  |
| $T_{\text{d(off)}}$  | Turn-off Delay Time                |   | --- | 39   | ---      |                  |
| $T_f$  | Turn-off Fall Time                 |   | --- | 33   | ---      |                  |
| $Q_g$  | Total Gate Charge                  | $V_{\text{DD}}=400\text{V}$ , $V_{\text{GS}}=10\text{V}$ ,<br>$I_D=7\text{A}$                     | --- | 20   | ---      | nC               |
| $Q_{\text{gs}}$  | Gate-Source Charge                 |   | --- | 4    | ---      |                  |
| $Q_{\text{gd}}$  | Gate-Drain Charge                  |   | --- | 7    | ---      |                  |
| <b>Source-Drain Characteristics</b> ( $T_J=25^\circ\text{C}$ ) |                                    |   |     |      |          |                  |
| $V_{\text{SD}}$  | Diode Forward Voltage <sup>②</sup> | $V_{\text{GS}}=0\text{V}$ , $I_S=7\text{A}$ , $T_J=25^\circ\text{C}$                              | --- | ---  | 1.4      | V                |
| $t_{\text{rr}}$  | Reverse Recovery Time              | $V_R=400\text{V}$ , $I_S=7\text{A}$ ,<br>$dI/dt=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$ | --- | 365  | ---      | nS               |
| $Q_{\text{rr}}$  | Reverse Recovery Charge            |   | --- | 3.4  | ---      | nC               |

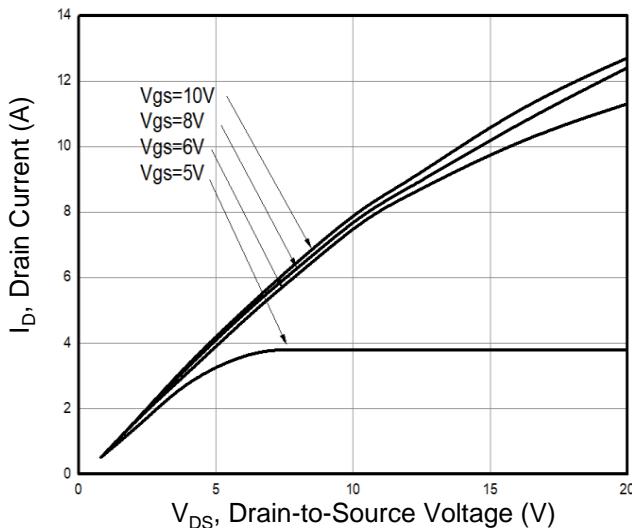
Note ④ : Pulse test (pulse width≤300us, duty cycle≤2%).

Note ⑤ : Guaranteed by design, not subject to production testing.

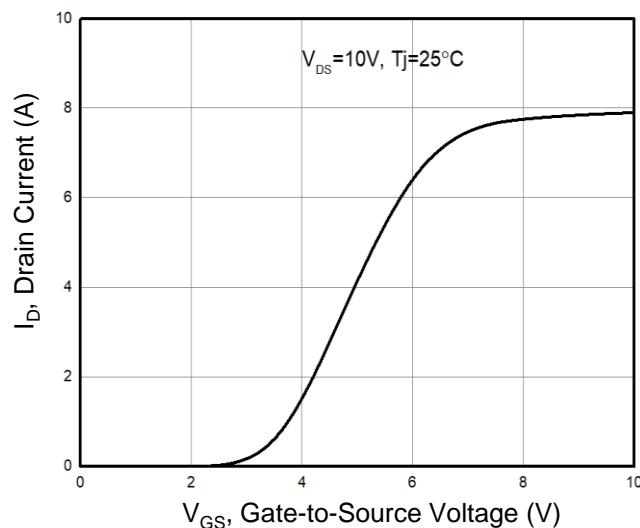
## N-Channel Enhancement Mode MOSFET

### Typical Characteristics

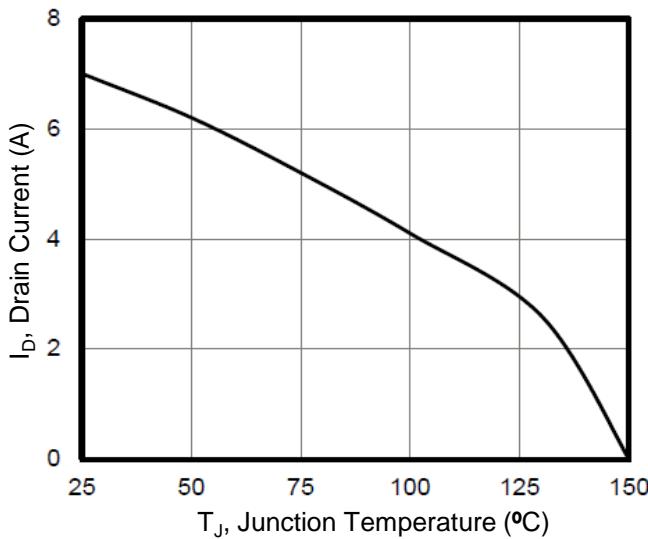
**Figure 1. Output Characteristics**



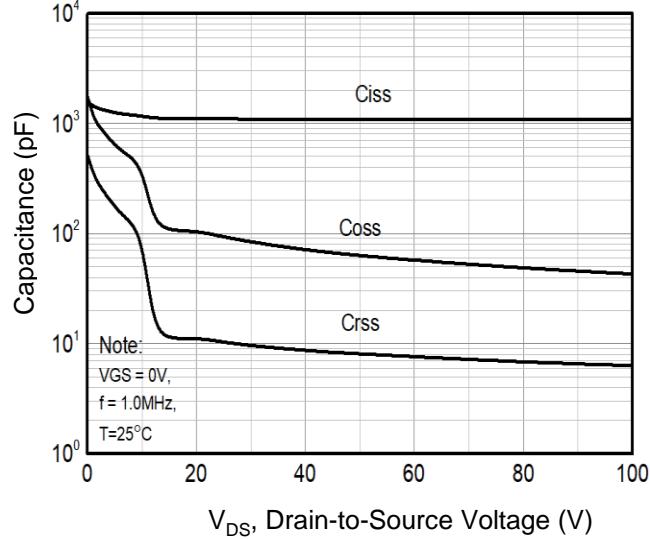
**Figure 2. Transfer Characteristics**



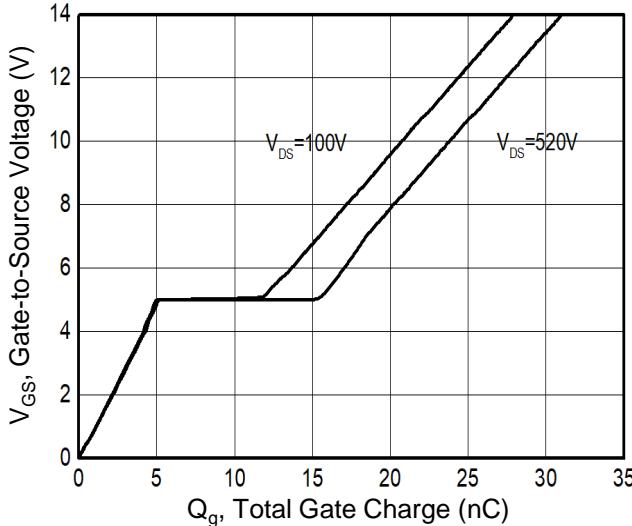
**Figure 3. Drain Current vs. Temperature**



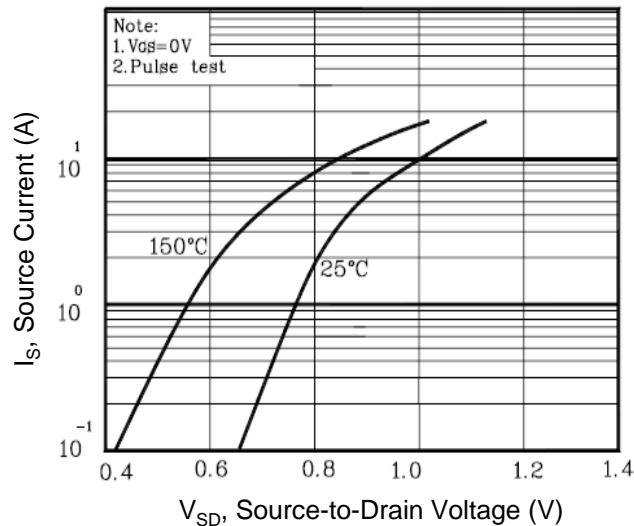
**Figure 4. Capacitance**



**Figure 5. Gate Charge**

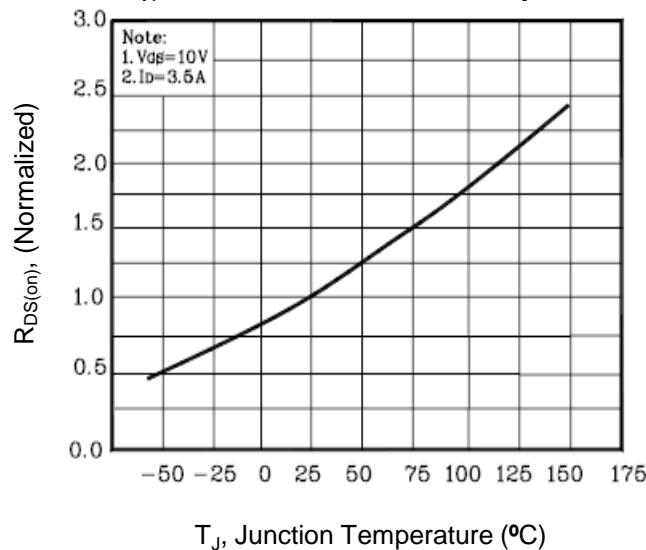


**Figure 6. Body Diode Forward Voltage**

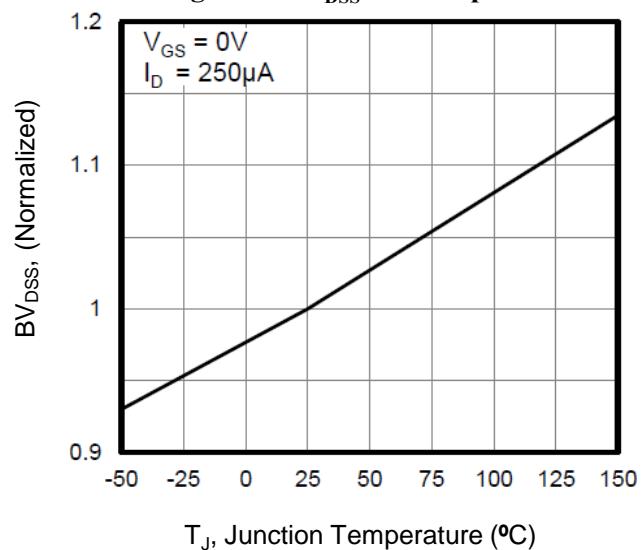


## N-Channel Enhancement Mode MOSFET

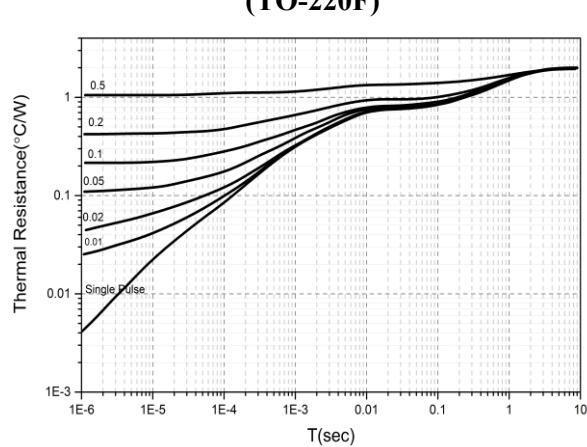
**Figure 7. On-Resistance vs. Temperature**



**Figure 8. BV<sub>DSS</sub> vs. Temperature**



**Figure 9. Transient Thermal Impedance  
(TO-220F)**



## N-Channel Enhancement Mode MOSFET

## TO-220F Package Outline Data

